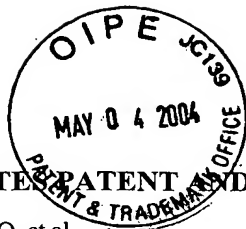


Docket No. 248348US3DIV



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Hiroshi TAKEMOTO, et al.

SERIAL NO: 10/770,459

GAU:

FILED: February 4, 2004

EXAMINER:

FOR: METHOD AND APPARATUS FOR ASSEMBLING PARTS

INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

SIR:

Applicant(s) wish to disclose the following information.

REFERENCES

- ☐ The applicant(s) wish to make of record the references listed on the attached form PTO-1449. Copies of the listed references are attached, where required, as are either statements of relevancy or any readily available English translations of pertinent portions of any non-English language references.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

RELATED CASES

- ☒ Attached is a list of applicant's issued patent(s) which may be related to the present application is attached along with PTO 1449.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

CERTIFICATION

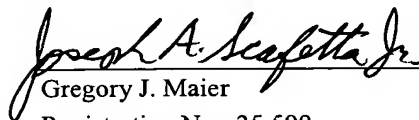
- ☐ Each item of information contained in this information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- ☐ No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

DEPOSIT ACCOUNT

- ☒ Please charge any additional fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit account number 15-0030. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

OBLON, SPIVAK, McCLELLAND,
MAIER & NEUSTADT, P.C.



Gregory J. Maier

Registration No. 25,599

Joseph A. Scafetta, Jr.

Registration No. 26, 803

Customer Number

22850

Tel. (703) 413-3000
Fax. (703) 413-2220
(OSMMN 05/03)

I:\USER\SSUL\RELATED CASES\248348US\COVER.DOC



LIST OF RELATED CASES

<u>Docket Number</u>	<u>Serial or Patent Number</u>	<u>Filing or Issue Date</u>	<u>Inventor/ Applicant</u>
0557-4578-3	6,217,684	04/17/01	MORII et al.
193124US3 DIV	6,435,241	08/20/02	MORII et al.
194684US3 DIV	6,503,358	01/07/03	TAKEMOTO et al.
200788US3 DIV	6,471,801	10/29/02	TAKEMOTO et al.
200794US3 DIV	6,544,376	04/08/03	TAKEMOTO et al.
202198US3 DIV	6,726,806	04/27/04	TAKEMOTO et al.
248348US3 DIV*	10/770,459	02/04/04	TAKEMOTO et al.

*Present Application; listed for information

GJM/sb

I:\MEMREL\247S-248S\248348US LIST.DOC

Form PTO 1449
(Modified)U.S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICE

ATTY DOCKET NO.

248348US3DIV

SERIAL NO.

10/770,459

LIST OF REFERENCES CITED BY APPLICANT

APPLICANT

Hiroshi TAKEMOTO, et al.

FILING DATE

February 4, 2004

GROUP



U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
	AA	6,217,684	04/17/01	Morii et al.			
	AB	6,435,241	08/20/02	Morii et al.			
	AC	6,503,358	01/07/03	Takemoto et al.			
	AD	6,471,801	10/29/02	Takemoto et al.			
	AE	6,544,376	04/08/03	Takemoto et al.			
	AF	6,726,806	04/27/04	Takemoto et al.			
	AG						
	AH						
	AI						
	AJ						
	AK						
	AL						
	AM						
	AN						

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	TRANSLATION	
					YES	NO
	AO					
	AP					
	AQ					
	AR					
	AS					
	AT					
	AU					
	AV					

OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)

	AW	
	AX	
	AY	
	AZ	<input type="checkbox"/> Additional References sheet(s) attached

Examiner

Date Considered

*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.